

RoHS

COMPLIANT

HALOGEN

FREE

Vishay Siliconix

P-Channel 30-V (D-S) MOSFET

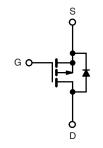
| PRODUCT SUMMARY | | | | | | |
|---------------------|-----------------------------------|------------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^{a, e} | Q _g (Typ.) | | | |
| - 30 | 0.042 at V _{GS} = - 10 V | - 6 | 7 nC | | | |
| - 30 | 0.072 at V_{GS} = - 4.5 V | - 6 | 7110 | | | |

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Load Switch
- Notebook Adaptor Switch



P-Channel MOSFET

SO-8 S D 8 S D 7 2 S D 6 G D 4 5 Top View

Ordering Information: Si4485DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter | Symbol | Limit | Unit | | |
|--|-----------------------------------|------------------|-----------------------|----|--|
| Drain-Source Voltage | V _{DS} | - 30 | v | | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | |
| | T _C = 25 °C | | - 6 ^e | | |
| Continuous Drain Correct (T. 150 °C) | T _C = 70 °C | 1. [| - 6 ^e | | |
| Continuous Drain Current ($T_J = 150 \ ^{\circ}C$) | T _A = 25 °C | | - 5.9 ^{b, c} | | |
| | T _A = 70 °C | | - 4.7 ^{b, c} | А | |
| Pulsed Drain Current | | I _{DM} | - 25 | | |
| | T _C = 25 °C | | - 4.2 | | |
| Continous Source-Drain Diode Current | T _A = 25 °C | I _S | - 2 ^{b, c} | | |
| | T _C = 25 °C | | 5 | | |
| Maximum Power Dissipation | T _C = 70 °C | | 3.2 | w | |
| | T _A = 25 °C | P _D – | 2.4 ^{b, c} | VV | |
| | T _A = 70 °C | 1 | 1.5 ^{b, c} | | |
| Operating Junction and Storage Temperatur | T _J , T _{stq} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{b, d} | $t \le 10 s$ | R _{thJA} | 42 | 53 | °C/W | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 19 | 25 | 0/11 | | |

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.

e. Package Limited.

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|--|-------------------------|---|-------|-------|-------|-------|--|
| Static | • | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \mu A$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | | - 19 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | $1D = -200 \mu A$ | | 4.4 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ | - 1.2 | | - 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| | I _{DSS} | V _{DS} = - 30 V, V _{GS} = 0 V | | | - 1 | μA | |
| Zero Gate Voltage Drain Current | | $V_{DS} = -30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C | | | - 5 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \leq$ - 5 V, V_{GS} = - 10 V | - 25 | | | Α | |
| | D | V _{GS} = - 10 V, I _D = - 5.9 A | 0.035 | | 0.042 | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{\text{D}} = -4.5 \text{ A}$ | | 0.060 | 0.072 | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 5.9 A | | 10 | | S | |
| Dynamic ^b | | · · · · · · · · · · · · · · · · · · · | | | | | |
| Input Capacitance | C _{iss} | | | 590 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 115 | | | |
| Reverse Transfer Capacitance | C _{rss} | 1 | | 93 | | | |
| Total Gate Charge | Qg | $V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -5.9 \text{ A}$ | | 13.6 | 21 | nC | |
| Total Gate Charge | | | | 7 | 11 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 5.9 A | | 2.3 | | | |
| Gate-Drain Charge | Q _{gd} | | | 3.2 | | | |
| Gate Resistance | Rg | f = 1 MHz | 1 | 5 | 10 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 30 | 45 | | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 3.2 Ω | | 25 | 38 | - ns | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 4.7 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 16 | 24 | | |
| Fall Time | t _f |] [| | 8 | 16 | | |
| Turn-On Delay Time | t _{d(on)} | | | 8 | 16 | | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 3.2 Ω | | 10 | 20 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong$ - 4.7 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 18 | 27 | | |
| Fall Time | t _f | 1 1 | | 8 | 16 | | |
| Drain-Source Body Diode Characteristic | cs | | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | - 4.2 | ۸ | |
| Pulse Diode Forward Current | I _{SM} | | | | - 25 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 4.7 A, V _{GS} = 0 V | | - 0.8 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 17 | 26 | ns | |
| Body Diode Reverse Recovery Charge Q _{rr} | | I _F = - 4.7 A, dl/dt = 100 A/μs, T _J = 25 °C | | 9 | 18 | nC | |
| Reverse Recovery Fall Time | t _a | $F = -4.7 \text{ A}, \text{ u/ul} = 100 \text{ A/} \mu \text{s}, \text{ I}_{\text{J}} = 25 ^{\circ} \text{C}$ | | 10 | | - ns | |
| Reverse Recovery Rise Time | t _b | 1 1 | | 7 | | | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

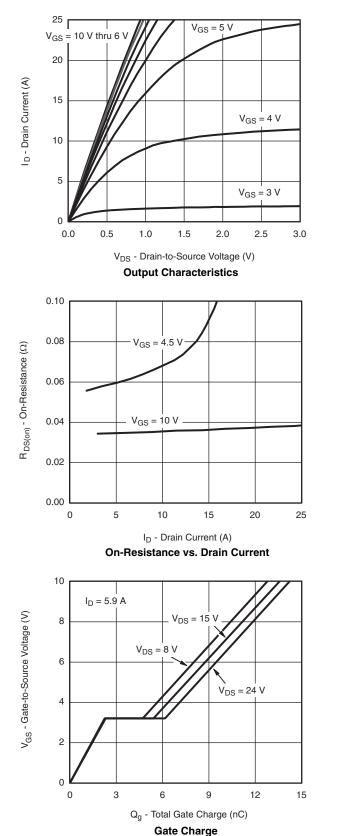
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

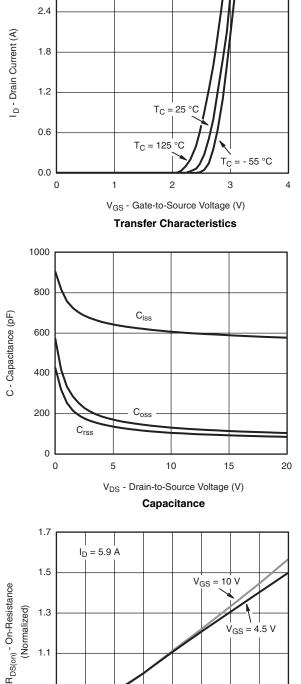


Si4485DY

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



3.0

1.3

1.1

0.9

0.7

- 50

- 25

0

25

50

T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

75

100

125 150

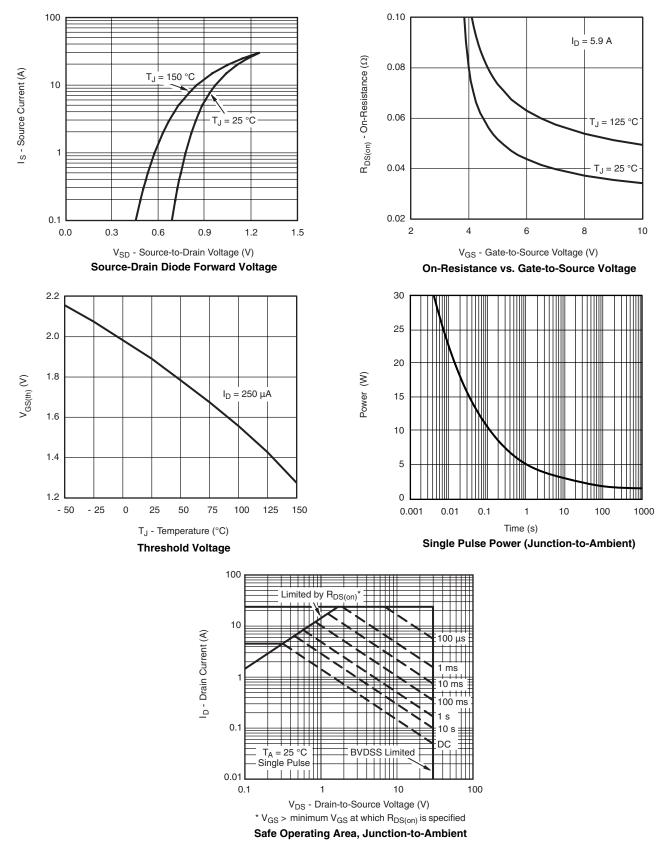
 $V_{GS} = 4.5 V$

Si4485DY

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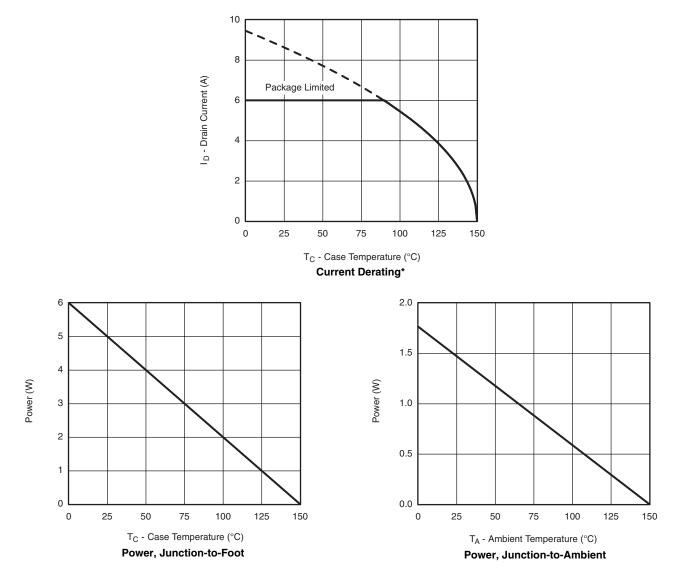
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Si4485DY Vishay Siliconix

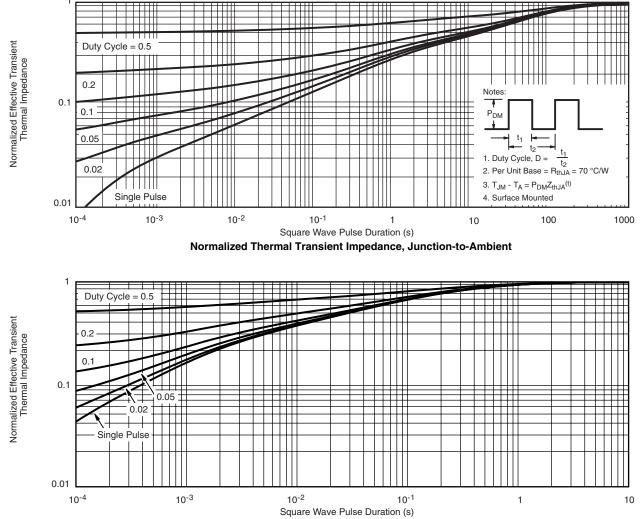
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64989.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





| | MILLIM | IETERS | INCHES | | |
|---|--------|--------|-----------|-------|--|
| DIM | Min | Мах | Min | Max | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | |
| е | 1.27 | BSC | 0.050 BSC | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | |
| q | 0° | 8° | 0° | 8° | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | |

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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